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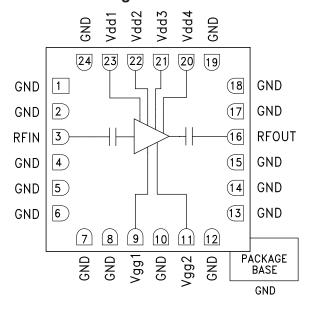
# GaAs PHEMT MMIC DRIVER AMPLIFIER, 18 - 40 GHz

## Typical Applications

The HMC635LC4 is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- LO Driver for Mixers
- Military & Space

## **Functional Diagram**



#### **Features**

Gain: 18.5 dB <sup>[2]</sup> P1dB: +22 dBm <sup>[2]</sup> Output IP3: +27 dBm

Saturated Power: +23.5 dBm @ 15% PAE [2]

Supply Voltage: +5V @ 280 mA 50 Ohm Matched Input/Output

24 Lead Ceramic 4x4mm SMT Package: 16mm<sup>2</sup>

## **General Description**

The HMC635LC4 is a GaAs PHEMT MMIC Driver Amplifier die which operates between 18 and 40 GHz. The amplifier provides 18.5 dB of gain, +27 dBm Output IP3, and +22 dBm of output power at 1 dB gain compression, while requiring 280 mA from a +5V supply. Ideal as a driver amplifier for microwave radio applications, or as an LO driver for mixers operating between 18 and 40 GHz, the HMC635LC4 is capable of providing up to +23.5 dBm of saturated output power at 15% PAE. The amplifier's I/Os are DC blocked and internally matched to 50 Ohms making it ideal for integration into Multi-Chip-Modules (MCMs).

# **Electrical Specifications**

 $T_A = +25^{\circ} \text{ C}$ , Vdd = Vdd1, 2, 3, 4 = +5V, Idd = Idd1 + Idd2 + Idd3 + Idd4 = 280mA [1]

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range		18 - 36		36 - 40		GHz	
Gain [2]		18.5		15	17.5		dB
Gain Variation Over Temperature		0.045	0.06		0.045	0.06	dB/ °C
Input Return Loss		13			7		dB
Output Return Loss		10			7		dB
Output Power for 1 dB Compression (P1dB) [2]		22		16	21		dBm
Saturated Output Power (Psat) [2]		23.5			21.5		dBm
Output Third Order Intercept (IP3)		27		21	26		dBm
Noise Figure [2]		7			7		dB
Total Supply Current (ldd1 + ldd2 + ldd3 + ldd4)		280			280		mA

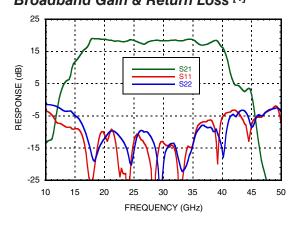
<sup>[1]</sup> Adjust Vgg1 = Vgg2 between -2 to 0V to achieve Idd= 280 mA Typical.

 $<sup>\</sup>cite{box}$  Board loss subtracted out for gain, power and noise figure measurements.

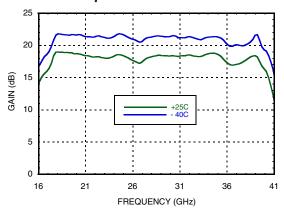


# GaAs PHEMT MMIC DRIVER AMPLIFIER, 18 - 40 GHz

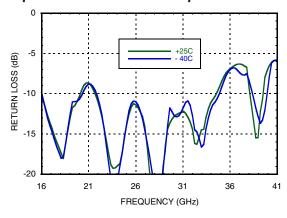
# Broadband Gain & Return Loss [1]



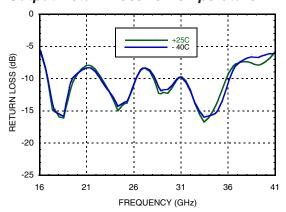
#### Gain vs. Temperature [1]



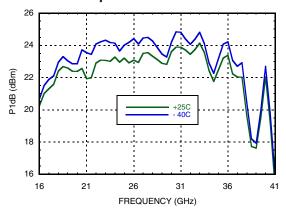
#### Input Return Loss vs. Temperature



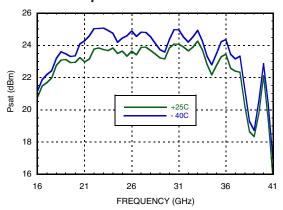
## Output Return Loss vs. Temperature



### P1dB vs. Temperature [1]



Psat vs. Temperature [1]

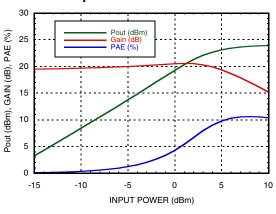


[1] Board loss subtracted out for gain, power and noise figure measurements.

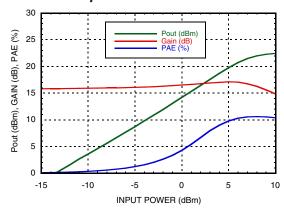


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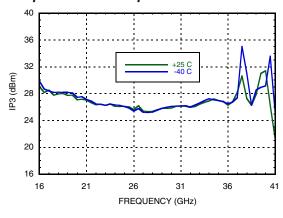
#### Power Compression @ 30 GHz [1]



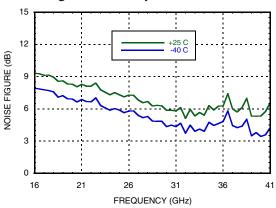
### Power Compression @ 40 GHz [1]



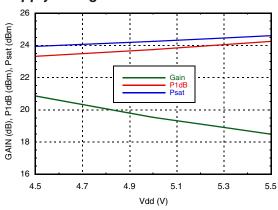
#### Output IP3 vs. Temperature



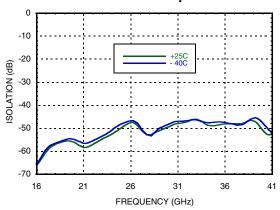
Noise Figure vs. Temperature [1]



## Gain & Power vs. Supply Voltage @ 30 GHz [1]



#### Reverse Isolation vs. Temperature



[1] Board loss subtracted out for gain, power and noise figure measurements.



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## **Absolute Maximum Ratings**

Drain Bias Voltage (Vdd1, 2, 3, 4)	+5.5V	
Gate Bias Voltage (Vgg1, Vgg2)	-3 to 0V	
RF Input Power (RFIN)(Vdd = +5 Vdc)	+5 Vdc) 15 dBm	
Channel Temperature	175 °C	
Continuous Pdiss (T= 70 °C) (derate 15.1 mW/°C above 70 °C)	1.575 W 66.4 °C/W	
Thermal Resistance (channel to package base)		
Storage Temperature	-65 to +150 °C	
Operating Temperature	Femperature -55 to +85 °C	

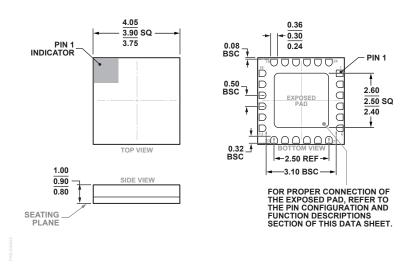
### Typical Supply Current vs. Vdd

Vdd (V)	Idd (mA)
4.5	277
5.0	280
5.5	286

Note: Amplifier will operate over full voltage ranges shown above



## **Outline Drawing**



24-Terminal Ceramic Leadless Chip Carrier [LCC] (E-24-1)
Dimensions shown in millimeters.

# Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC635LC4	Alumina, White	Gold over Nickel	MSL3 <sup>[1]</sup>	H635 XXXX

<sup>[1]</sup> Max peak reflow temperature of 260  $^{\circ}\text{C}$ 

<sup>[2] 4-</sup>Digit lot number XXXX



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# **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1, 2, 4 - 8, 10, 12 - 15, 17 - 19, 24, Ground Paddle	GND	These pins and package bottom must be connected to RF/DC ground	GND =
3	RFIN	This pad is AC coupled and matched to 50 Ohms.	RFIN O
16	RFOUT	This pad is AC coupled and matched to 50 Ohms.	—
9, 11	Vgg1, Vgg2	Gate control for amplifier, please follow "MMIC Amplifier Biasing Procedure" application note. See assembly diagram for required external components.	Vgg1 Vgg2
20 - 23	Vdd4 - Vdd1	Power Supply Voltage for the amplifier. See assembly diagram for required external components.	OVdd4,3,2,1

# **Application Circuit**

